



DEVICE TYPE:				SEMPAC, INC. Open-Pak™ Technologies www.sempac.com 568 E. WEDDELL DRIVE, SUITE 5 SUNNYVALE, CALIFORNIA 94089 PHONE: (408) 400-9002 FAX: (408) 400-9006							
CUSTOMER:			DIE SIZE:								
WIRE TYPE/ SIZE:			NO. OF WIRES:								
THIRD ANGLE PROJECTION		REVISIONS				28 Lead 7mm x 7mm MLP Open-Pak Bonding Diagram					
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETER DO NOT SCALE DRAWING		ECN NO.	DATE	DESCRIPTION	APPROVED						
		10496	10/27/06	PRODUCTION RELEASE	D.BENANDO						
DRAWN BY	W. GRIFFITTS	DATE	10/26/05	PACKAGE SIZE:	7.00mm x 7.00mm	SIZE	PART NO.	MLP7X7-28-OP-01	REV	3	
APP BY	P. FLASKERUD	DATE	10/26/05	DIE PAD SIZE:	5.200mm x 5.200mm	SCALE	24X	CAD FILE	MLP7X7-28-OP-01-B-R3.DWG	SHEET	1 OF 1